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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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### T-1 (3mm) SOLID STATE LAMP

Part Number: WP710A10YD14V Yellow

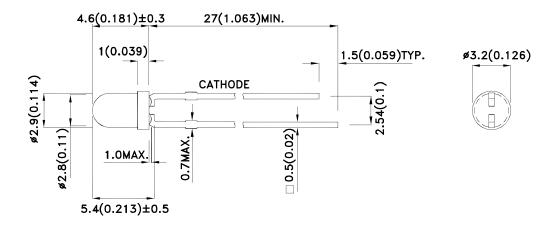
#### **Features**

- Low power consumption.
- Popular T-1 diameter package.
- General purpose leads.
- Reliable and rugged.
- Long life solid state reliability.
- Available on tape and reel.
- 14V internal resistor.
- RoHS compliant.

#### Description

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- Lead spacing is measured where the leads emerge from the package.
   The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

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### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] V= 14V		Viewing Angle [1]
		,	Min.	Тур.	201/2
WP710A10YD14V	Yellow (GaAsP/GaP)	Yellow Diffused	6	11	40°

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Yellow	590		nm	VF=14V
λD [1]	Dominant Wavelength	Yellow	588		nm	VF=14V
Δλ1/2	Spectral Line Half-width	Yellow	35		nm	VF=14V
lF	Forward Current	Yellow	10.5	13.5	mA	VF=14V
lR	Reverse Current	Yellow		10	uA	V <sub>R</sub> = 5V

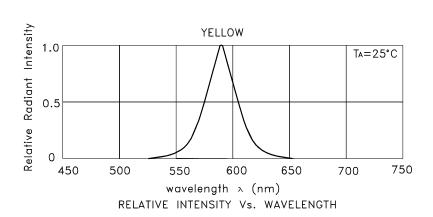
#### Absolute Maximum Ratings at TA=25°C

Absolute Maximum Natings at 1A-23 C					
Parameter	Yellow	Units			
Power dissipation	160	mW			
Forward Voltage	16	V			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +70°C	<u> </u>			
Storage Temperature	-40°C To +85°C				
Lead Solder Temperature [1]	260°C For 3 Seconds				
Lead Solder Temperature [2]	260°C For 5 Seconds				

- 2mm below package base.
   5mm below package base.

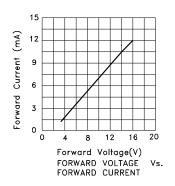
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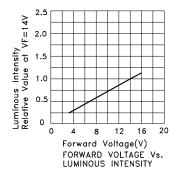
Note: 1.Wavelength: +/-1nm.

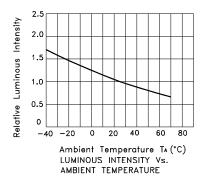


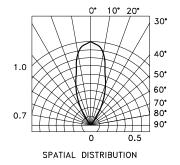
#### Yellow

#### WP710A10YD14V







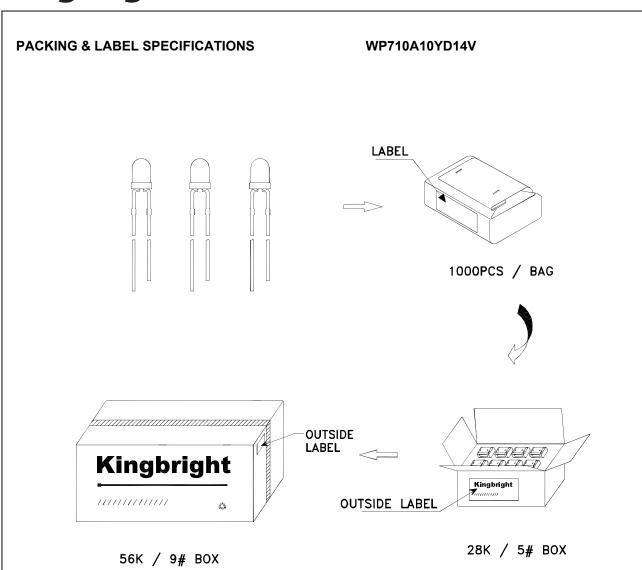


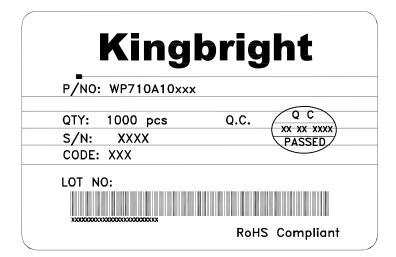
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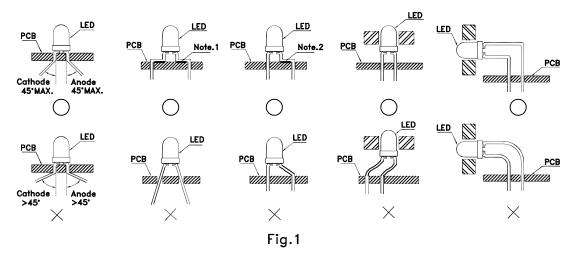




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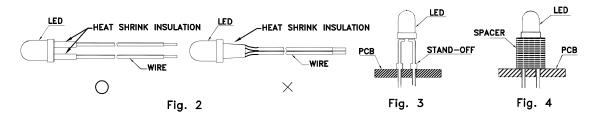
#### **PRECAUTIONS**

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead—forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



" $\bigcirc$  " Correct mounting method "imes" Incorrect mounting method

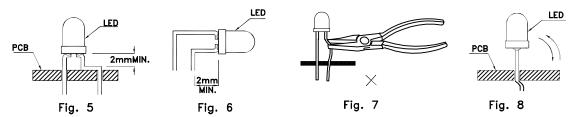
- 2. When soldering wire to the LED, use individual heat—shrink tubing to insulate the exposed leads to prevent accidental contact short—circuit. (Fig.2)
- 3.Use stand—offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



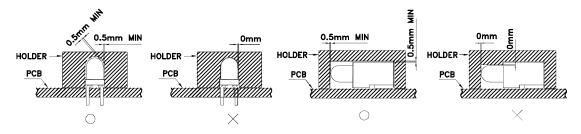
- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)

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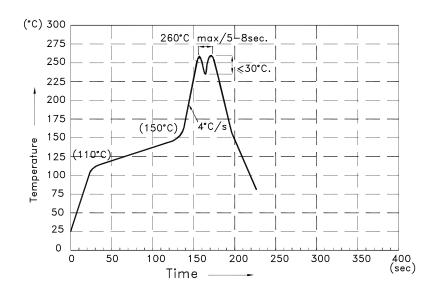
6. Do not bend the leads more than twice. (Fig. 8)



7. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



- 8. The tip of the soldering iron should never touch the lens epoxy.
- 9. Through—hole LEDs are incompatible with reflow soldering.
- 10. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 11. Recommended Wave Soldering Profile for Kingbright Thru-Hole Products



#### NOTES:

- 1.Recommend the wave temperature 245°C $\sim$ 260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering, the PCB top-surface temperature should be kept below 105°C.
- 5.No more than once.

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